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ality Syst	
Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.	
	»
	12 11 10 09 08 13
	□ 14 □ O7
	01 06 06 02 03 04 05 05 05 05 05 05 05 05 05 05 05 05 05
Top Material: Al Backside Material: Si Bond Pad Size: .004" X .004" Backside Potential: Mask Ref:	

DIE SIZE .051" X .047"

THICKNESS .015"

DATE: 5/21/12

P/N: 74LS00

DG 10.1.2 Rev B, 7/19/02

MFG: ST Micro

APPROVED BY: DK